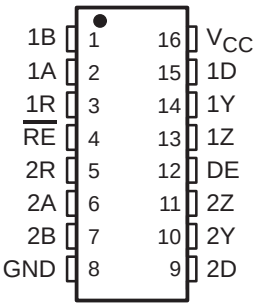
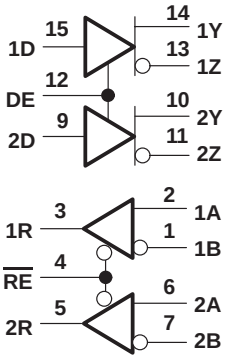
- **Typically Meets or Exceeds ANSI TIA/EIA-644-1995 Standard**
- **Operates From a Single 2.4-V to 3.6-V Supply**
- **Signaling Rates up to 400 Mbit/s**
- **Bus-Terminal ESD Exceeds 12 kV**
- **Low-Voltage Differential Signaling With Typical Output Voltages of 285 mV and a 100 Ω Load**
- **Propagation Delay Times**
  - **Driver: 1.7 ns Typ**
  - **Receiver: 3.7 ns Typ**
- **Power Dissipation at 200 MHz**
  - **Driver: 25 mW Typical**
  - **Receiver: 60 mW Typical**
- **LVTTL Input Levels Are 5 V Tolerant**
- **Driver Is High Impedance When Disabled or With V_{CC} < 1.5 V**
- **Receiver Has Open-Circuit Fail Safe**
- **Available in Thin Shink Outline Packaging With 20-mil Lead Pitch**

SN65LVDS1050PW
(Marked as **DL1050** or **DLS1050**)
(TOP VIEW)





DRIVER FUNCTION TABLE

INPUTS		OUTPUTS	
D	**DE**	**Y**	**Z**
L	H	L	H
H	H	H	L
Open	H	L	H
X	L	Z	Z

H = high level, L = low level, Z = high impedance,
X = don't care

description

The SN65LVDS1050 is similar to the SN65LVDS050 except that it is characterized for operation with a lower supply voltage range and packaged in the thin shrink outline package for portable battery-powered applications.

The differential line drivers and receivers use low-voltage differential signaling (LVDS) to achieve signaling rates as high as 400 Mbps. The drivers provide a minimum differential output voltage magnitude of 247 mV into a 100-Ω load and receipt of 100-mV signals with up to 1 V of ground potential difference between a transmitter and receiver.

RECEIVER FUNCTION TABLE

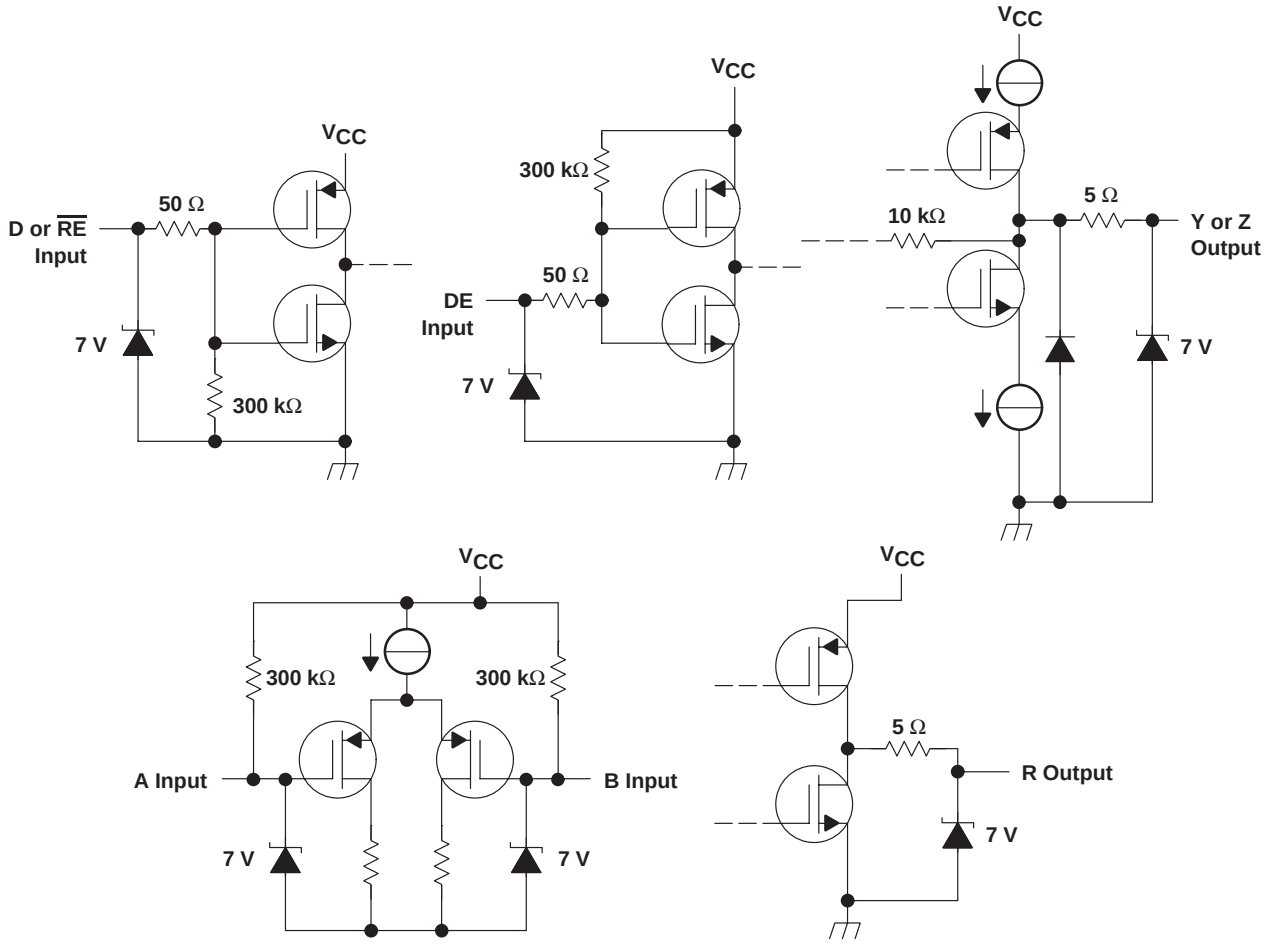
INPUTS		OUTPUT
$V_{ID} = V_A - V_B$	**$\overline{RE}$**	**R**
$V_{ID} \geq 100$ mV	L	H
–100 MV < V_{ID} < 100 mV	L	?
$V_{ID} \leq -100$ mV	L	L
Open	L	H
X	H	Z

H = high level, L = low level, Z = high impedance,
X = don't care

The intended application of this device and signaling technique is for point-to-point baseband data transmission over controlled impedance media of approximately 100-Ω characteristic impedance. The transmission media may be printed-circuit board traces, backplanes, or cables. Note: The ultimate rate and distance of data transfer is dependent upon the attenuation characteristics of the media, the noise coupling to the environment and other application-specific characteristics.

The SN65LVDS1050 is characterized for operation from –40°C to 85°C.

equivalent input and output schematic diagrams



absolute maximum ratings over operating free-air temperature (unless otherwise noted)†

Supply voltage range, V_{CC} (see Note 1) . . . . . –0.5 V to 4 V
Voltage range (D, R, DE, $\overline{RE}$) . . . . . –0.5 V to 6 V
Voltage range (Y, Z, A, and B) . . . . . –0.5 V to 4 V
Electrostatic discharge: Y, Z, A, B , and GND (see Note 2) . . . . . CLass 3, A:12 kV, B:600 V
All terminals . . . . . Class 3, A:7 kV, B:500 V
Continuous power dissipation . . . . . See Dissipation Rating Table
Storage temperature range . . . . . –65°C to 150°C
Lead temperature 1,6 mm (1/16 inch) from case for 10 seconds . . . . . 250°C

† Stresses beyond those listed under “absolute maximum ratings” may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under “recommended operating conditions” is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTES: 1. All voltage values, except differential I/O bus voltages are with respect to network ground terminal.
2. Tested in accordance with MIL-STD-883C Method 3015.7.

DISSIPATION RATING TABLE

PACKAGE	$T_A \le 25°C$ POWER RATING	DERATING FACTOR ABOVE $T_A = 25°C$	$T_A = 85°C$ POWER RATING
PW	774 mW	6.2 mW/°C	402 mW

recommended operating conditions (see Note 3)

	MIN	NOM	MAX	UNIT
Supply voltage, V_{CC}	2.4	2.7	3.6	V
High-level input voltage, V_{IH}	2			V
Low-level input voltage, V_{IL}			0.8	V
Magnitude of differential input voltage, $\lvert V_{ID} \rvert$	0.1		0.6	V
Common–mode input voltage, V_{IC} (see Figure 8)	0		$2.4 - \frac{\lvert V_{ID} \rvert}{2}$	V
			$V_{CC}–0.8$	
Operating free–air temperature, T_A	–40		85	°C

NOTE 3: The common-mode input voltage, V_{IC}, is not fully 644 compliant when V_{CC} = 2.4 V.

device electrical characteristics over recommended operating conditions (unless otherwise noted)

PARAMETER		TEST CONDITIONS	MIN	TYP†	MAX	UNIT
I_{CC}	Supply current	Driver and receiver enabled, No receiver load, Driver R_L = 100 Ω		12	20	mA
		Driver enabled, Receiver disabled, R_L = 100 Ω		10	16	
		Driver disabled, Receiver enabled, No load		3	6	
		Disabled		0.5	1	

† All typical values are at 25°C and with a 2.7-V supply.

driver electrical characteristics over recommended operating conditions (unless otherwise noted)

PARAMETER			TEST CONDITIONS	MIN	TYP	MAX	UNIT
$\|V_{OD}\|$	Differential output voltage magnitude		R_L = 100Ω, See Figure 1 and Figure 2	247	285	454	mV
$\Delta\|V_{OD}\|$	Change in differential output voltage magnitude between logic states			–50		50	
$V_{OC(SS)}$	Steady-state common-mode output voltage		See Figure 3	1.125		1.375	V
$\Delta V_{OC(SS)}$	Change in steady-state common-mode output voltage between logic states			–50		50	mV
$V_{OC(PP)}$	Peak-to-peak common-mode output voltage				50	150	mV
I_{IH}	High-level input current	DE	V_{IH} = 5 V		–0.5	–20	µA
		D			2	20	
I_{IL}	Low-level input current	DE	V_{IL} = 0.8 V		–0.5	–10	µA
		D			2	20	
I_{OS}	Short-circuit output current		V_{OY} or V_{OZ} = 0 V		3	10	mA
			V_{OD} = 0 V		3	10	
I_{OZ}	High-impedance output current		V_{OD} = 600 mV			±1	µA
			V_O = 0 V or V_{CC}			±1	
$I_{O(OFF)}$	Power-off output current		V_{CC} = 0 V, V_O = 3.6 V			±1	µA
C_{IN}	Input capacitance				3		pF

receiver electrical characteristics over recommended operating conditions (unless otherwise noted)

PARAMETER		TEST CONDITIONS	MIN	TYP†	MAX	UNIT
V_{ITH+}	Positive-going differential input voltage threshold	See Figure 5			100	mV
$V_{ITH–}$	Negative-going differential input voltage threshold		–100			
V_{OH}	High-level output voltage	I_{OH} = –8 mA	2			V
V_{OL}	Low-level output voltage	I_{OL} = 8 mA			0.4	V
I_I	Input current (A or B inputs)	V_I = 0	–2		–20	µA
		V_I = 2.4 V	–1.2			
$I_{I(OFF)}$	Power-off input current (A or B inputs)	V_{CC} = 0			±20	µA
I_{IH}	High-level input current (enables)	V_{IH} = 5 V			±10	µA
I_{IL}	Low-level input current (enables)	V_{IL} = 0.8 V			±10	µA
I_{OZ}	High-impedance output current	V_O = 0 or 5 V			±10	µA

† All typical values are at 25°C and with a 2.7-V supply.

driver switching characteristics over recommended operating conditions (unless otherwise noted)

PARAMETER		TEST CONDITIONS	MIN	TYP†	MAX	UNIT
t_{PLH}	Propagation delay time, low-to-high-level output	R_L = 100Ω, C_L = 10 pF, See Figure 2		1.7	2.7	ns
t_{PHL}	Propagation delay time, high-to-low-level output			1.7	3	ns
t_r	Differential output signal rise time			0.8	1	ns
t_f	Differential output signal fall time			0.8	1	ns
$t_{sk(p)}$	Pulse skew ($\|t_{pHL} - t_{pLH}\|$)			300		ps
$t_{sk(o)}$	Channel-to-channel output skew‡			150		ps
t_{PZH}	Propagation delay time, high-impedance-to-high-level output	See Figure 4		7.8	10	ns
t_{PZL}	Propagation delay time, high-impedance-to-low-level output			7.3	10	ns
t_{PHZ}	Propagation delay time, high-level-to-high-impedance output			5.2	10	ns
t_{pLZ}	Propagation delay time, low-level-to-high-impedance output			6.6	10	ns

† All typical values are at 25°C and with a 2.7-V supply.
‡ $t_{sk(o)}$ is the maximum delay time difference between drivers on the same device.

receiver switching characteristics over recommended operating conditions (unless otherwise noted)

PARAMETER		TEST CONDITIONS	MIN	TYP†	MAX	UNIT
t_{PLH}	Propagation delay time, low-to-high-level output	C_L = 10 pF, See Figure 6		3.7	5.2	ns
t_{PHL}	Propagation delay time, high-to-low-level output			3.7	4.5	ns
$t_{sk(p)}$	Pulse skew ($\|t_{pHL} - t_{pLH}\|$)			0.3		ns
t_r	Output signal rise time			0.8	1.5	ns
t_f	Output signal fall time			0.8	1.5	ns
t_{PZH}	Propagation delay time, high-level-to-high-impedance output	See Figure 7		5.4		ns
t_{PZL}	Propagation delay time, low-level-to-low-impedance output			6.3		ns
t_{PHZ}	Propagation delay time, high-impedance-to-high-level output			6.1		ns
t_{PLZ}	Propagation delay time, low-impedance-to-high-level output			6.9		ns

† All typical values are at 25°C and with a 2.7-V supply.

PARAMETER MEASUREMENT INFORMATION

driver

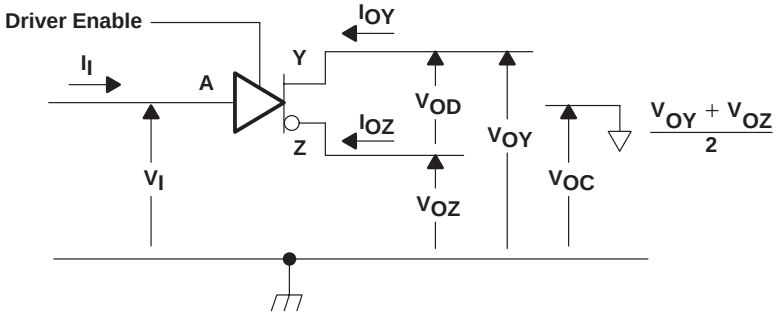
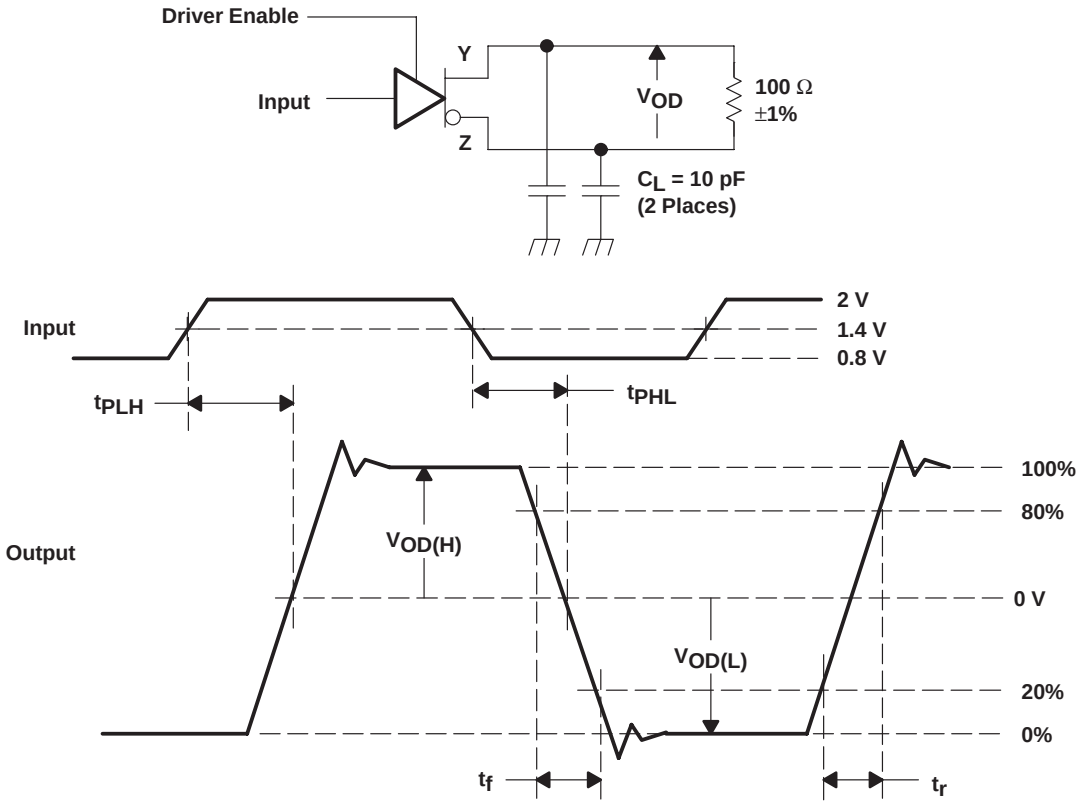


Figure 1. Driver Voltage and Current Definitions

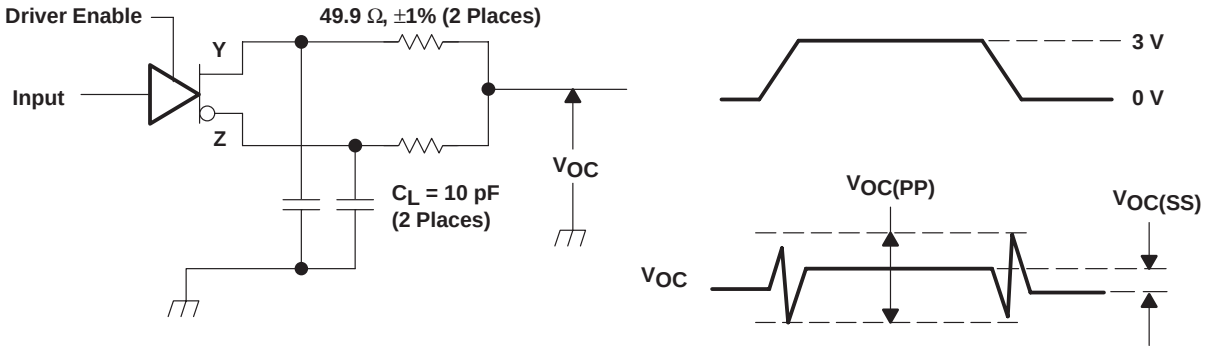
PARAMETER MEASUREMENT INFORMATION

driver (continued)



NOTE A: All input pulses are supplied by a generator having the following characteristics: t_r or $t_f \leq 1$ ns, pulse repetition rate (PRR) = 50 Mpps, pulse width = 10 ± 0.2 ns . C_L includes instrumentation and fixture capacitance within 0,06 mm of the D.U.T.

Figure 2. Test Circuit, Timing, and Voltage Definitions for the Differential Output Signal

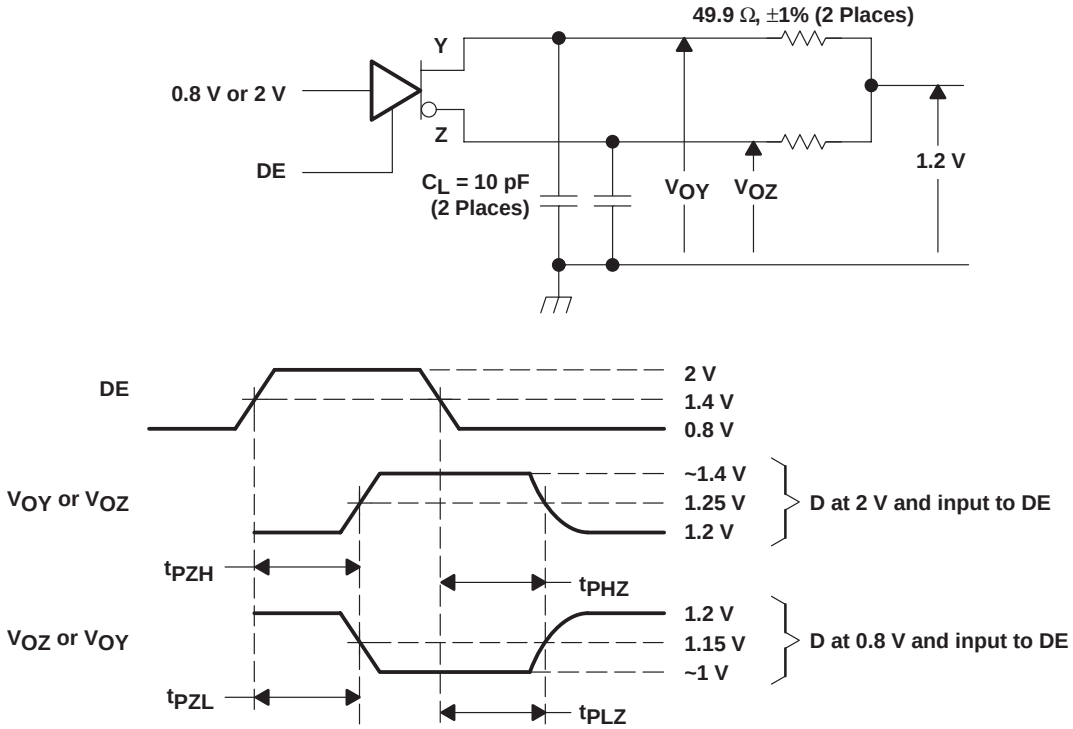


NOTE A: All input pulses are supplied by a generator having the following characteristics: t_r or $t_f \leq 1$ ns, pulse repetition rate (PRR) = 50 Mpps, pulse width = 10 ± 0.2 ns . C_L includes instrumentation and fixture capacitance within 0,06 mm of the D.U.T. The measurement of $V_{OC(PP)}$ is made on test equipment with a –3 dB bandwidth of at least 300 MHz.

Figure 3. Test Circuit and Definitions for the Driver Common-Mode Output Voltage

PARAMETER MEASUREMENT INFORMATION

driver (continued)



NOTE A: All input pulses are supplied by a generator having the following characteristics: t_r or $t_f \leq 1$ ns, pulse repetition rate (PRR) = 0.5 Mpps, pulse width = 500 ± 10 ns . C_L includes instrumentation and fixture capacitance within 0,06 mm of the D.U.T.

Figure 4. Enable and Disable Time Circuit and Definitions

PARAMETER MEASUREMENT INFORMATION

receiver

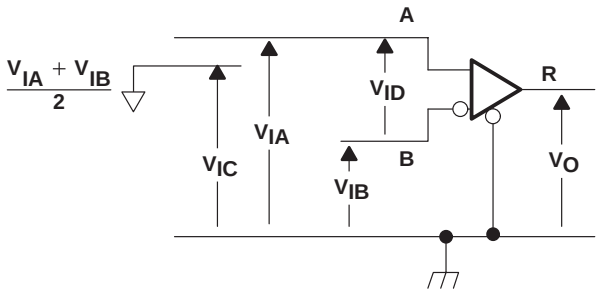


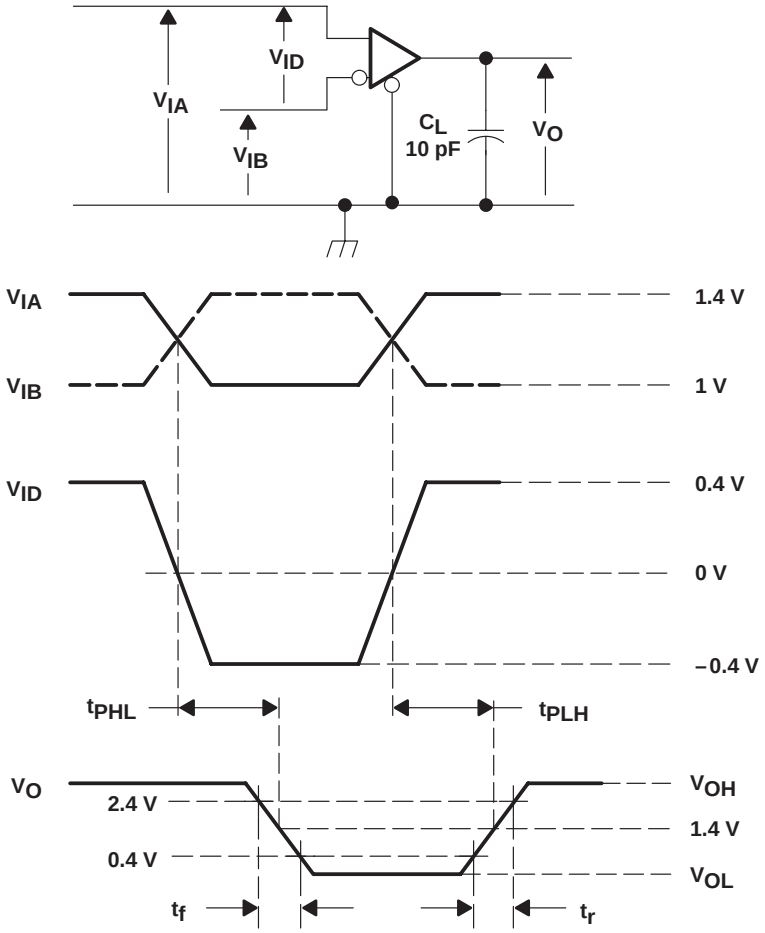
Figure 5. Receiver Voltage Definitions

Table 1. Receiver Minimum and Maximum Input Threshold Test Voltages

APPLIED VOLTAGES (V)		RESULTING DIFFERENTIAL INPUT VOLTAGE (mV)	RESULTING COMMON-MODE INPUT VOLTAGE (V)
V_{IA}	V_{IB}	V_{ID}	V_{IC}
1.25	1.15	100	1.2
1.15	1.25	–100	1.2
2.4	2.3	100	2.35
2.3	2.4	–100	2.35
0.1	0	100	0.05
0	0.1	–100	0.05
1.5	0.9	600	1.2
0.9	1.5	–600	1.2
2.4	1.8	600	2.1
1.8	2.4	–600	2.1
0.6	0	600	0.3
0	0.6	–600	0.3

PARAMETER MEASUREMENT INFORMATION

receiver (continued)

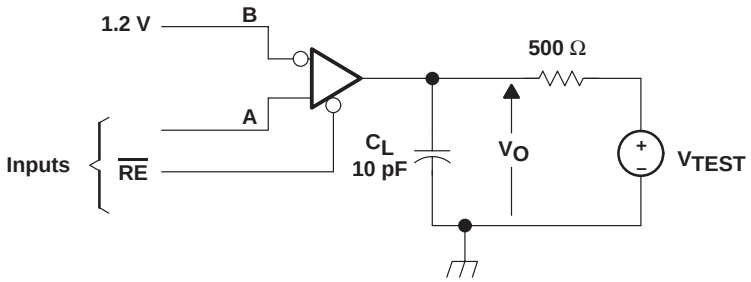


NOTE A: All input pulses are supplied by a generator having the following characteristics: t_r or $t_f \le 1$ ns, pulse repetition rate (PRR) = 50 Mpps, pulse width = 10 ± 0.2 ns. C_L includes instrumentation and fixture capacitance within 0,06 m of the D.U.T.

Figure 6. Timing Test Circuit and Waveforms

PARAMETER MEASUREMENT INFORMATION

receiver (continued)



NOTE A: All input pulses are supplied by a generator having the following characteristics: t_r or $t_f \leq 1$ ns, pulse repetition rate (PRR) = 0.5 Mpps, pulse width = 500 ± 10 ns. C_L includes instrumentation and fixture capacitance within 0,06 m of the D.U.T.

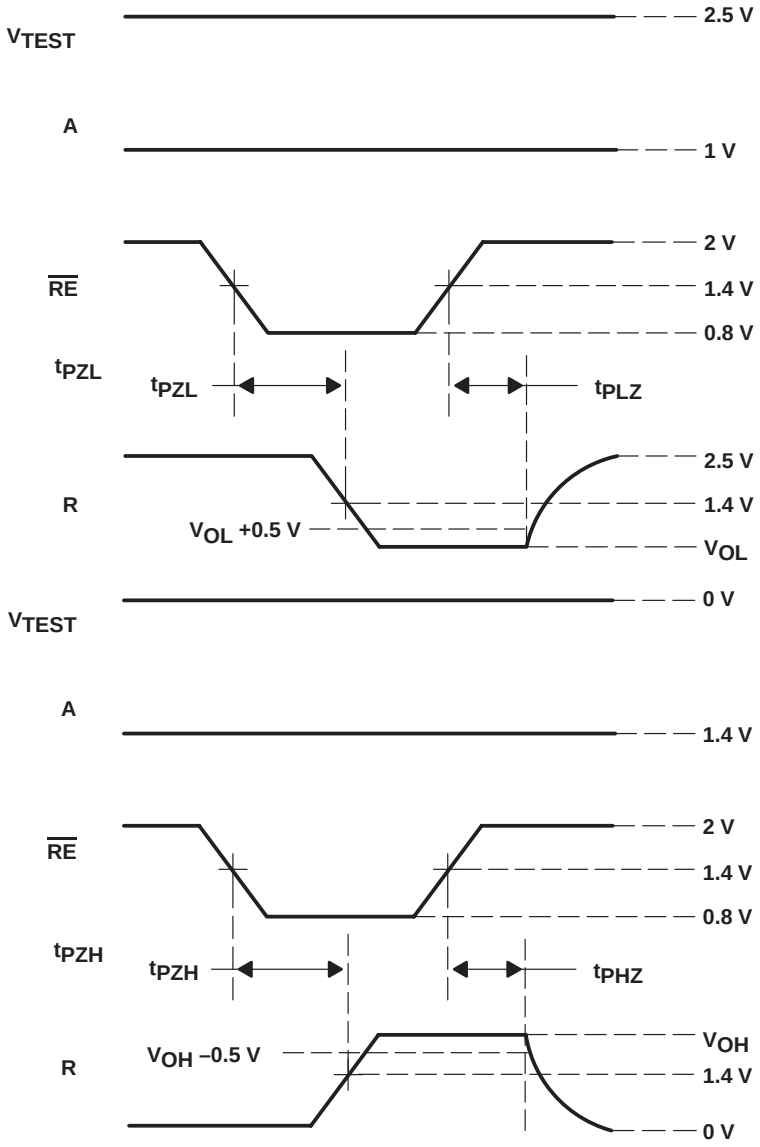


Figure 7. Enable/Disable Time Test Circuit and Waveforms

TYPICAL CHARACTERISTICS

RECEIVER
COMMON-MODE INPUT VOLTAGE
vs
DIFFERENTIAL INPUT VOLTAGE

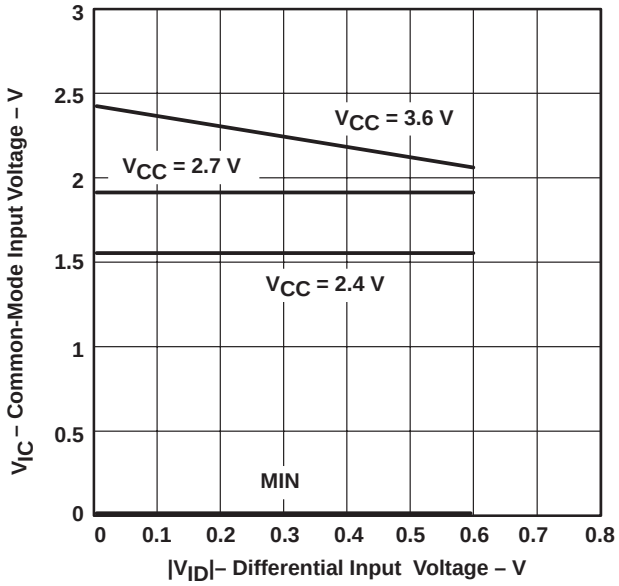


Figure 8

DRIVER
LOW-LEVEL OUTPUT VOLTAGE
vs
LOW-LEVEL OUTPUT CURRENT

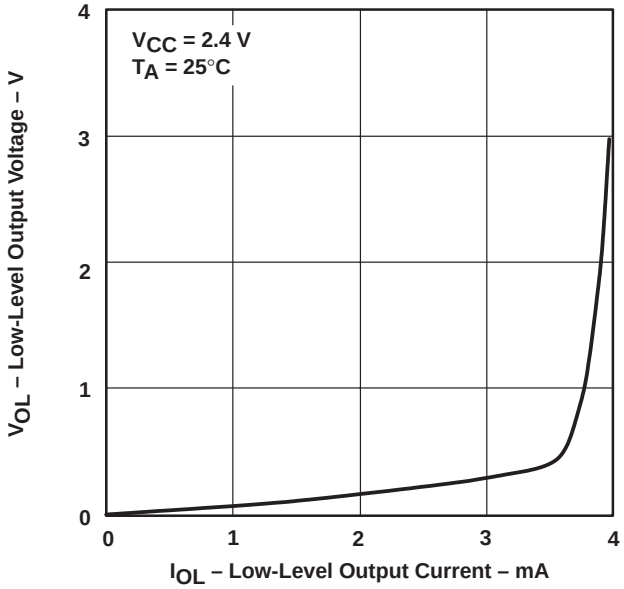


Figure 9

DRIVER
HIGH-LEVEL OUTPUT VOLTAGE
vs
HIGH-LEVEL OUTPUT CURRENT

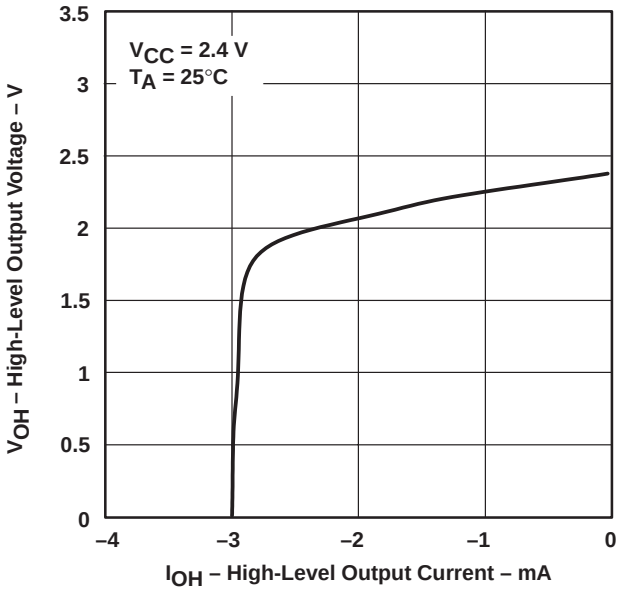


Figure 10

TYPICAL CHARACTERISTICS

RECEIVER
LOW-LEVEL OUTPUT VOLTAGE
vs
LOW-LEVEL OUTPUT CURRENT

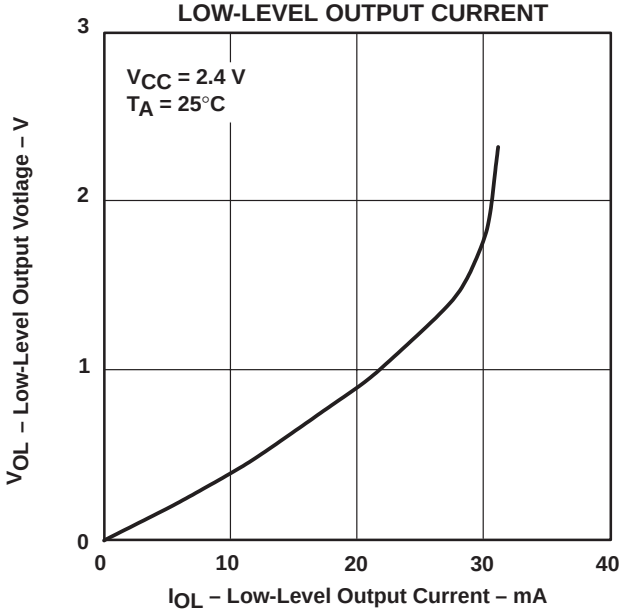


Figure 11

RECEIVER
HIGH-LEVEL OUTPUT VOLTAGE
vs
HIGH-LEVEL OUTPUT CURRENT

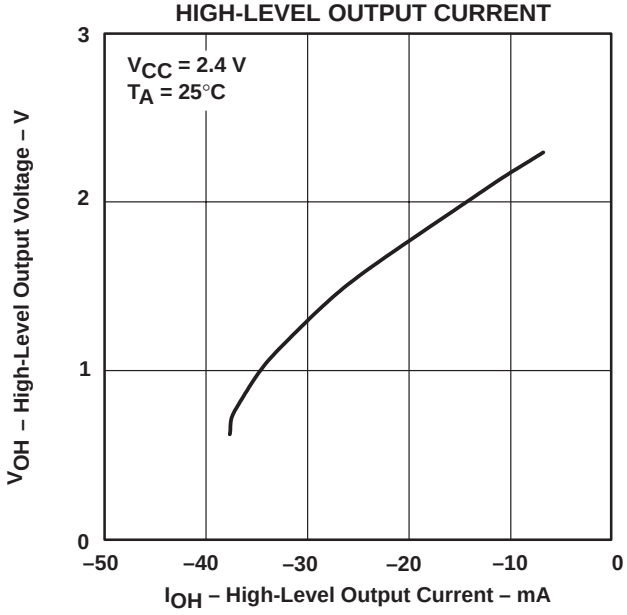


Figure 12

DRIVER
HIGH-TO-LOW LEVEL PROPAGATION DELAY TIME
vs
FREE-AIR TEMPERATURE

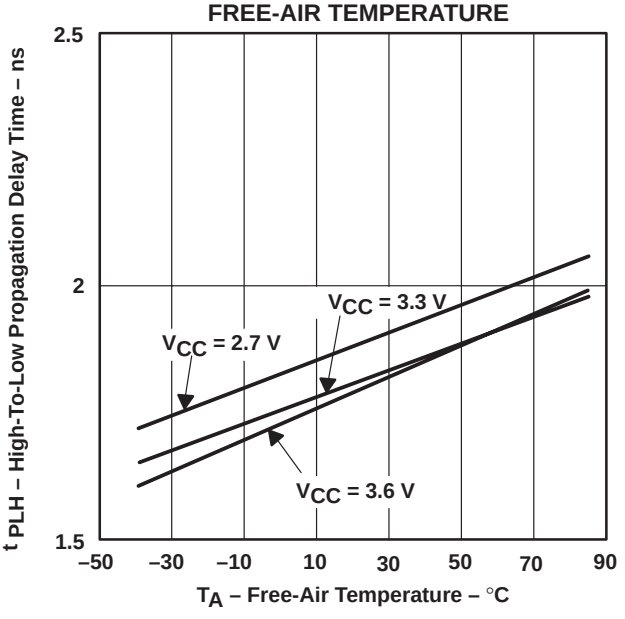


Figure 13

DRIVER
LOW-TO-HIGH LEVEL PROPAGATION DELAY TIME
vs
FREE-AIR TEMPERATURE

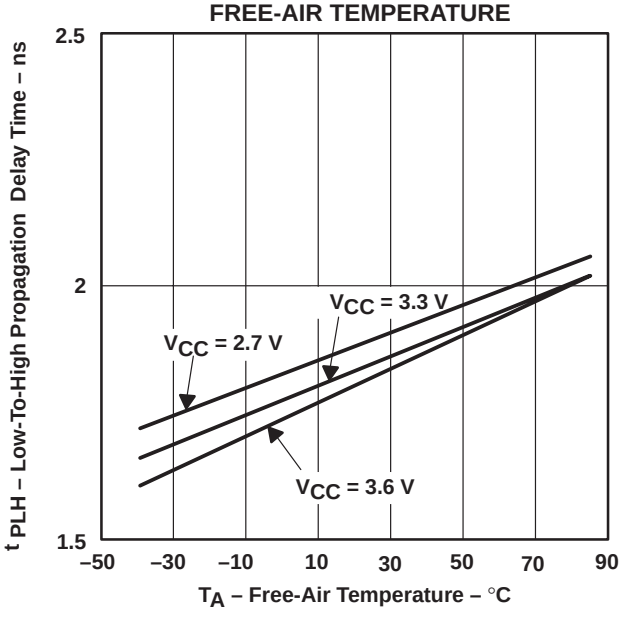


Figure 14

TYPICAL CHARACTERISTICS

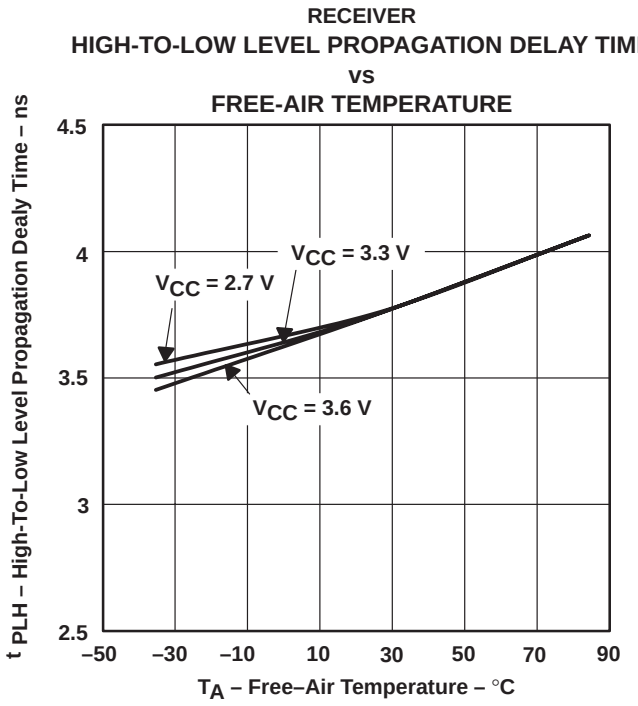


Figure 15

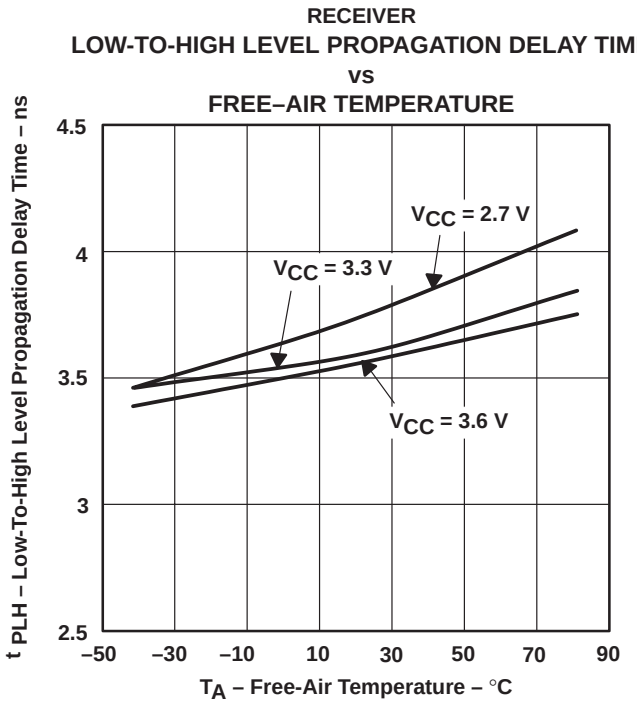


Figure 16

APPLICATION INFORMATION

The devices are generally used as building blocks for high-speed point-to-point data transmission. Ground differences are less than 1 V with a low common–mode output and balanced interface for very low noise emissions. Devices can interoperate with RS-422, PECL, and IEEE-P1596. Drivers/Receivers maintain ECL speeds without the power and dual supply requirements.

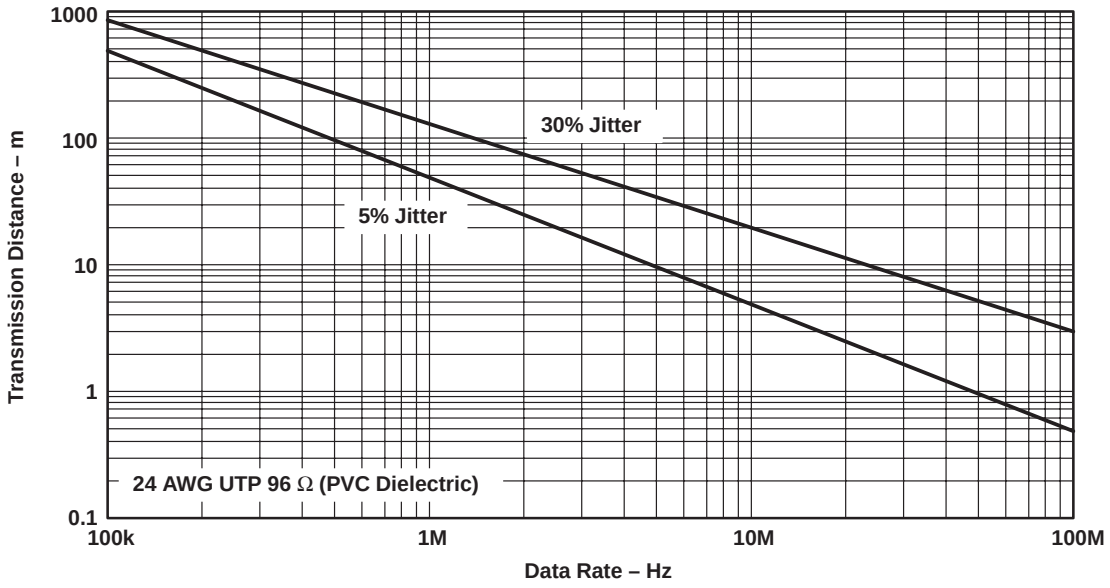


Figure 17. Data Transmission Distance Versus Rate

APPLICATION INFORMATION

fail safe

One of the most common problems with differential signaling applications is how the system responds when no differential voltage is present on the signal pair. The LVDS receiver is like most differential line receivers, in that its output logic state can be indeterminate when the differential input voltage is between –100 mV and 100 mV and within its recommended input common-mode voltage range. TI's LVDS receiver is different in how it handles the open-input circuit situation, however.

Open-circuit means that there is little or no input current to the receiver from the data line itself. This could be when the driver is in a high-impedance state or the cable is disconnected. When this occurs, the LVDS receiver will pull each line of the signal pair to near V_{CC} through 300-kΩ resistors as shown in Figure 11. The fail-safe feature uses an AND gate with input voltage thresholds at about 2.3 V to detect this condition and force the output to a high-level, regardless of the differential input voltage.

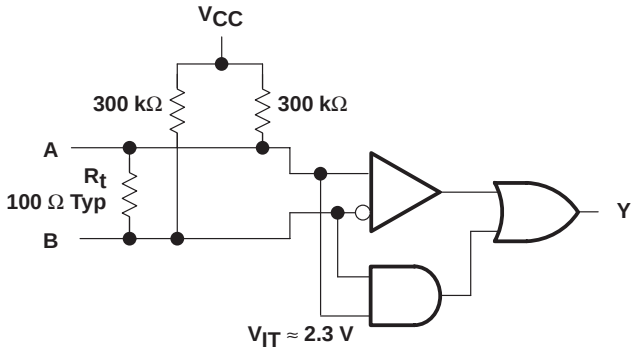


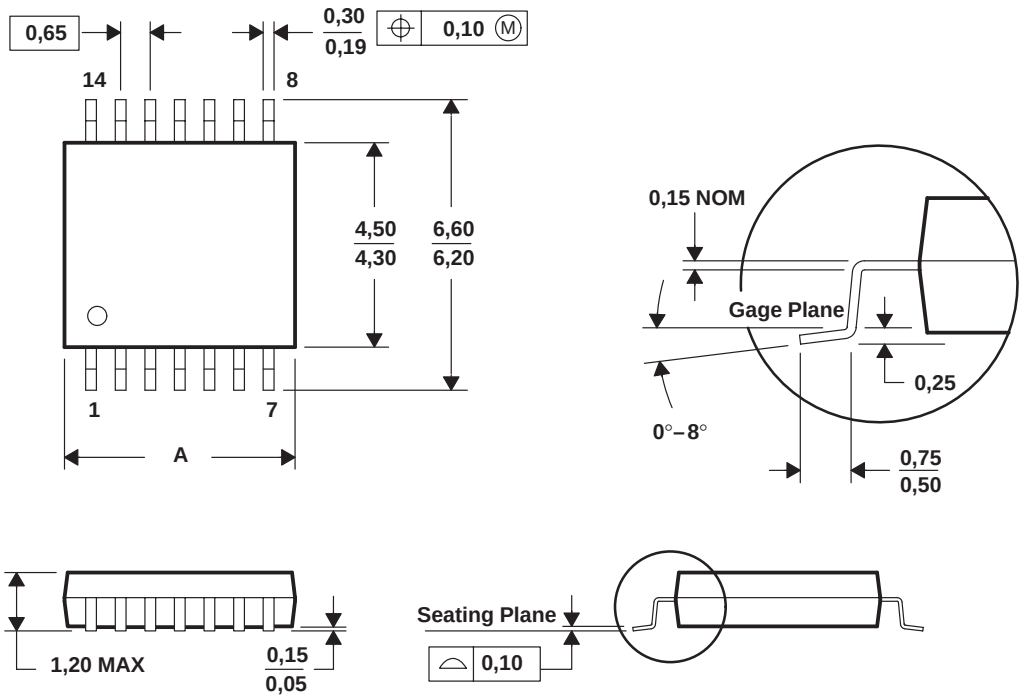
Figure 18. Open-Circuit Fail Safe of the LVDS Receiver

It is only under these conditions that the output of the receiver will be valid with less than a 100-mV differential input voltage magnitude. The presence of the termination resistor, Rt, does not affect the fail-safe function as long as it is connected as shown in the figure. Other termination circuits may allow a dc current to ground that could defeat the pullup currents from the receiver and the fail-safe feature.

MECHANICAL DATA

PW (R-PDSO-G)** **PLASTIC SMALL-OUTLINE PACKAGE**

14 PINS SHOWN



DIM \ PINS **	8	14	16	20	24	28
A MAX	3,10	5,10	5,10	6,60	7,90	9,80
A MIN	2,90	4,90	4,90	6,40	7,70	9,60

4040064/F 01/97

NOTES: A. All linear dimensions are in millimeters.
B. This drawing is subject to change without notice.
C. Body dimensions do not include mold flash or protrusion not to exceed 0,15.
D. Falls within JEDEC MO-153

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